	Application No.	Applicant(s)		
	10/664,614	RYKEN ET AL.	RYKEN ET AI	
Notice of Allowability	Examiner	Art Unit	<u> </u>	
	Hoang V Nguyen	2821	Pr Pr	
The MAILING DATE of this communication at All claims being allowable, PROSECUTION ON THE MERITS herewith (or previously mailed), a Notice of Allowance (PTOL NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATEN of the Office or upon petition by the applicant. See 37 CFR 1	S IS (OR REMAINS) CLOSED in -85) or other appropriate commu T RIGHTS. This application is s	this application. If not include nication will be mailed in due	ded e course. THIS	
1. This communication is responsive to application filed of	on 19 September 2003.			
2. 🔀 The allowed claim(s) is/are <u>1-20</u> .				
3. 🔀 The drawings filed on 19 September 2003 are accepte	d by the Examiner.			
 4. ☐ Acknowledgment is made of a claim for foreign priority a) ☐ All b) ☐ Some* c) ☐ None of the: 1. ☐ Certified copies of the priority documents It 2. ☐ Certified copies of the priority documents It 3. ☐ Copies of the certified copies of the priority International Bureau (PCT Rule 17.2(a)). * Certified copies not received: 	have been received. have been received in Application	n No	ation from the	
Applicant has THREE MONTHS FROM THE "MAILING DA' noted below. Failure to timely comply will result in ABANDO THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		a reply complying with the re	equirements	
5. A SUBSTITUTE OATH OR DECLARATION must be so INFORMAL PATENT APPLICATION (PTO-152) which			NOTICE OF	
 CORRECTED DRAWINGS (as "replacement sheets") (a) including changes required by the Notice of Drafts 1) hereto or 2) to Paper No./Mail Date (b) including changes required by the attached Exami Paper No./Mail Date Identifying Indicia such as the application number (see 37 Cleach sheet. Replacement sheet(s) should be labeled as such DEPOSIT OF and/or INFORMATION about the dattached Examiner's comment regarding REQUIREMENT 	person's Patent Drawing Review ner's Amendment / Comment or FR 1.84(c)) should be written on the in the header according to 37 CFI eposit of BIOLOGICAL MATE	in the Office action of the drawings in the front (not the R 1.121(d). ERIAL must be submitted.	•	
Attachment(s) 1. ☑ Notice of References Cited (PTO-892) 2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-94) 3. ☐ Information Disclosure Statements (PTO-1449 or PTO/5 Paper No./Mail Date 4. ☐ Examiner's Comment Regarding Requirement for Depo of Biological Material	6. Interview Su Paper No./l SB/08), 7. Examiner's	formal Patent Application (PT Immary (PTO-413), Mail Date Amendment/Comment Statement of Reasons for All	,	
HOANG V. NGUYEN PRIMARY EXAMINEI				

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Allowable Subject Matter

1. Claims 1-20 are allowed.

2. The following is an examiner's statement of reasons for allowance:

Regarding claim 1, Channabasappa et al (US 2004/0090368 A1) discloses a microstrip antenna array comprising a dielectric layer; a plurality of rectangular shaped antenna elements mounted on the upper surface of the dielectric layer, the antenna elements being aligned with one another; an antenna feed network mounted on the substrate for connecting each of the antenna elements to an antenna feed network input terminal; and a ground plane affixed to a bottom surface of the dielectric layer. Channabasappa, however, fails to further teach a copper cross hatch pattern mounted on the upper surface of the dielectric layer around the periphery for each of the antenna elements wherein a gap forms between first, second and third edges of the periphery of each of the antenna elements and the copper cross hatch pattern; a band stop filter integrally formed with the antenna feed network on the bottom surface of the dielectric layer, the band stop filter providing for a minimum band-stop rejection of 60 decibels to isolate the RF carrier signals containing telemetry data from L-band radio frequency signals containing GPS data; and a second dielectric layer positioned below the first dielectric layer in alignment with the first dielectric layer.

Claims 2-9 are allowed for depending on claim 1.

Regarding claim 10, Channabasappa et al discloses a microstrip antenna array comprising a dielectric layer; a plurality of rectangular shaped antenna elements mounted on the upper surface of the dielectric layer, the antenna elements being aligned with one another; an antenna

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feed network mounted on the substrate for connecting each of the antenna elements to an antenna feed network input terminal; and a ground plane affixed to a bottom surface of the dielectric layer. Channabasappa, however, fails to further teach a copper cross hatch pattern mounted on the upper surface of the dielectric layer around the periphery for each of the antenna elements wherein a gap forms between first, second and third edges of the periphery of each of the antenna elements and the copper cross hatch pattern; a band stop filter integrally formed with the antenna feed network on the bottom surface of the dielectric layer, the band stop filter including a plurality of etched copper open circuit stubs connected to the main transmission line, the band stop filter providing for a minimum band-stop rejection of 60 decibels to isolate the RF carrier signals containing telemetry data from L-band radio frequency signals containing GPS data; and a second dielectric layer positioned below the first dielectric layer in alignment with the first dielectric layer.

Claims 11-16 are allowed for depending on claim 10.

Regarding claim 17, Channabasappa et al discloses a microstrip antenna array comprising a first dielectric layer; eight rectangular shaped antenna elements mounted on the upper surface of the dielectric layer, the antenna elements being aligned with one another; an antenna feed network mounted on the substrate for connecting each of the eight antenna elements to an antenna feed network input terminal; and a ground plane. Channabasappa, however, fails to further teach a copper cross hatch pattern mounted on the upper surface of the dielectric layer around the periphery for each of the eight antenna elements wherein a gap forms between first, second and third edges of the periphery of each of the antenna elements and the copper cross hatch pattern; a band stop filter integrally formed with the antenna feed network on the bottom

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surface of the dielectric layer, the band stop filter including six L-shaped etched copper open circuit stubs connected to the main transmission line; the band stop filter providing for a minimum band-stop rejection of 60 decibels to isolate the RF carrier signals containing telemetry data from L-band radio frequency signals containing GPS data; a second dielectric layer positioned below the first dielectric layer in alignment with the first dielectric layer; and a third dielectric layer positioned above the first dielectric layer in alignment with the first dielectric layer; wherein the ground plane being affixed to a bottom surface of the second dielectric layer.

Claims 18-20 are allowed for depending on claim 17.

3. Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

- 4. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. US 2004/002291 A1 discloses a stacked antenna array.
- 5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hoang V Nguyen whose telephone number is (571) 272-1825. The examiner can normally be reached on Mondays-Fridays from 9:00 a.m. to 5:00 p.m..

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Don Wong can be reached on (571) 272-1834. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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6. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Hvn 11/10/04

HOANG V. NGUYEN PRIMARY EXAMINER